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#### Details

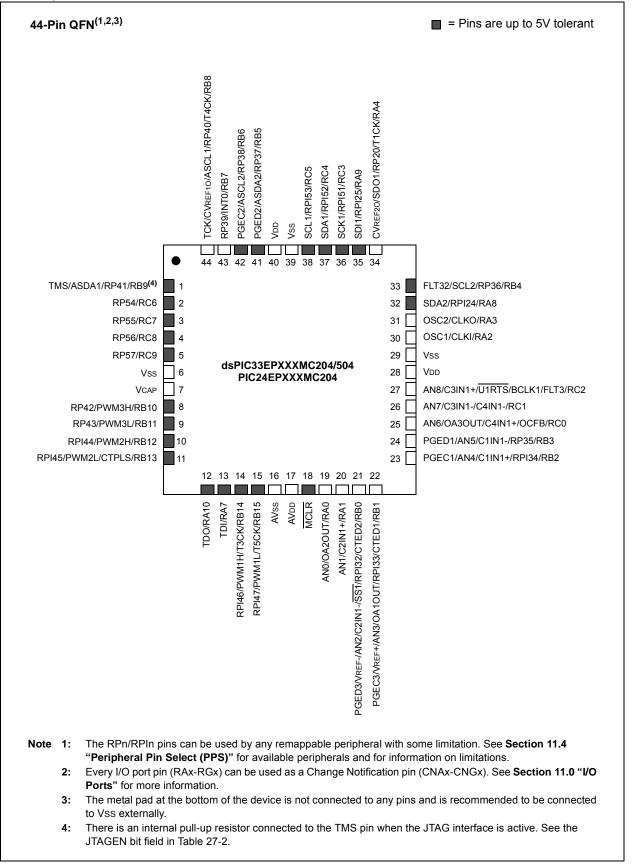
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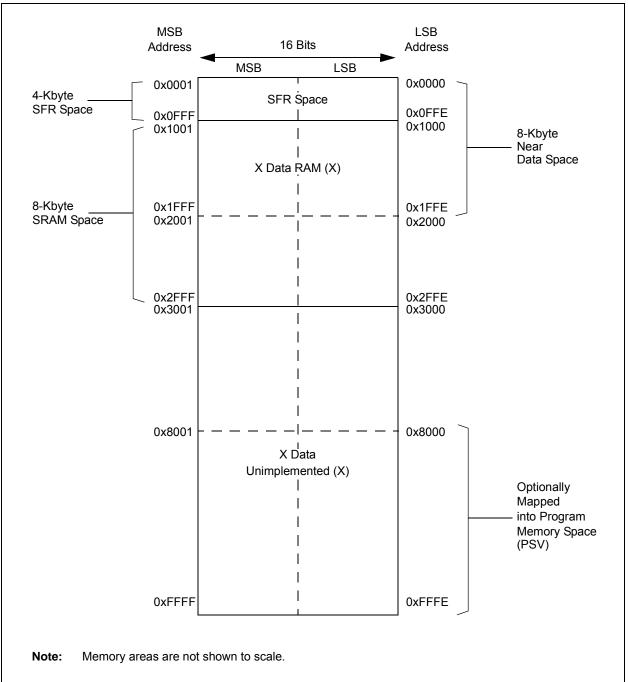
Detans	
Product Status	Active
Core Processor	PIC
Core Size	16-Bit
Speed	70 MIPs
Connectivity	I <sup>2</sup> C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, POR, PWM, WDT
Number of I/O	21
Program Memory Size	64KB (22K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	4K x 16
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 6x10b/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-VQFN Exposed Pad
Supplier Device Package	28-QFN-S (6x6)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24ep64gp202-i-mm

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## Pin Diagrams (Continued)







## TABLE 4-37: PMD REGISTER MAP FOR PIC24EPXXXGP20X DEVICES ONLY

File Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
PMD1	0760	T5MD	T4MD	T3MD	T2MD	T1MD	_	_	_	I2C1MD	U2MD	U1MD	SPI2MD	SPI1MD	_	_	AD1MD	0000
PMD2	0762	_	_	_	_	IC4MD	IC3MD	IC2MD	IC1MD	_		_	_	OC4MD	OC3MD	OC2MD	OC1MD	0000
PMD3	0764		_	_	—	_	CMPMD	_	-	CRCMD	_				_	I2C2MD	_	0000
PMD4	0766		_	_	—	_		_	-	—	_			REFOMD	CTMUMD	_	_	0000
PMD6	076A		—		—	_		_		—	_				—	—		0000
													DMA0MD					
PMD7	076C	_			_								DMA1MD	PTGMD	_			0000
	0700	_	_	_	_	_	_	_	_	_	_	_	DMA2MD	FIGMD	_	_	_	0000
													DMA3MD					

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

## TABLE 4-38: PMD REGISTER MAP FOR PIC24EPXXXMC20X DEVICES ONLY

File Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
PMD1	0760	T5MD	T4MD	T3MD	T2MD	T1MD	QEI1MD	PWMMD	—	I2C1MD	U2MD	U1MD	SPI2MD	SPI1MD	_	_	AD1MD	0000
PMD2	0762	_	_	_	_	IC4MD	IC3MD	IC2MD	IC1MD		_	_	_	OC4MD	OC3MD	OC2MD	OC1MD	0000
PMD3	0764	_	_	_	_	_	CMPMD	_	_	CRCMD	_	_	_	_	_	I2C2MD	_	0000
PMD4	0766	_	_	_	_	_	_	_	_		_	_	_	REFOMD	CTMUMD	_	_	0000
PMD6	076A	—	-	_			PWM3MD	PWM2MD	PWM1MD	_	—	—	_		—	_		0000
													DMA0MD					
PMD7	076C												DMA1MD	PTGMD				0000
FIVID7	0700	_	_	_	_	_	_	_	_	_	_	_	DMA2MD	FIGND	_	_	_	0000
													DMA3MD					

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

#### 4.8.1 DATA ACCESS FROM PROGRAM MEMORY USING TABLE INSTRUCTIONS

The TBLRDL and TBLWTL instructions offer a direct method of reading or writing the lower word of any address within the Program Space without going through Data Space. The TBLRDH and TBLWTH instructions are the only method to read or write the upper 8 bits of a Program Space word as data.

The PC is incremented by two for each successive 24-bit program word. This allows program memory addresses to directly map to Data Space addresses. Program memory can thus be regarded as two 16-bit-wide word address spaces, residing side by side, each with the same address range. TBLRDL and TBLWTL access the space that contains the least significant data word. TBLRDH and TBLWTH access the space that contains the upper data byte.

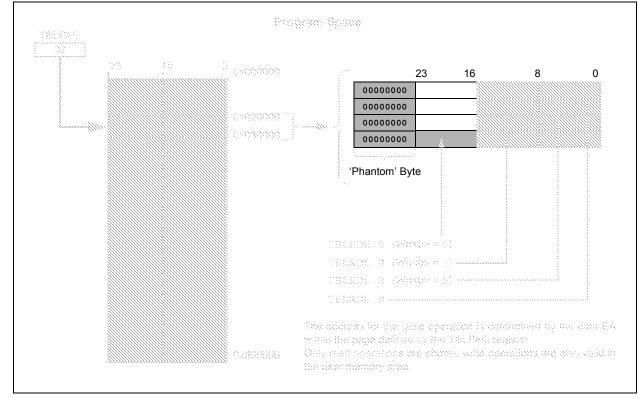
Two table instructions are provided to move byte or word-sized (16-bit) data to and from Program Space. Both function as either byte or word operations.

- TBLRDL (Table Read Low):
  - In Word mode, this instruction maps the lower word of the Program Space location (P<15:0>) to a data address (D<15:0>)

- In Byte mode, either the upper or lower byte of the lower program word is mapped to the lower byte of a data address. The upper byte is selected when Byte Select is '1'; the lower byte is selected when it is '0'.
- TBLRDH (Table Read High):
  - In Word mode, this instruction maps the entire upper word of a program address (P<23:16>) to a data address. The 'phantom' byte (D<15:8>) is always '0'.
  - In Byte mode, this instruction maps the upper or lower byte of the program word to D<7:0> of the data address in the TBLRDL instruction. The data is always '0' when the upper 'phantom' byte is selected (Byte Select = 1).

In a similar fashion, two table instructions, TBLWTH and TBLWTL, are used to write individual bytes or words to a Program Space address. The details of their operation are explained in **Section 5.0 "Flash Program Memory"**.

For all table operations, the area of program memory space to be accessed is determined by the Table Page register (TBLPAG). TBLPAG covers the entire program memory space of the device, including user application and configuration spaces. When TBLPAG<7> = 0, the table page is located in the user memory space. When TBLPAG<7> = 1, the page is located in configuration space.



## FIGURE 4-23: ACCESSING PROGRAM MEMORY WITH TABLE INSTRUCTIONS

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0			
CHEN	SIZE	DIR	HALF	NULLW						
bit 15							bit			
U-0	U-0	R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0			
	0-0	AMODE1	AMODE0	0-0	0-0	MODE1	MODE0			
bit 7		ANODET	7 WIODE0			MODET	bit			
Lovende										
Legend: R = Readab	lo hit	M - Mritabla	hit.		monted bit rec	ud aa '0'				
		W = Writable		-	mented bit, rea					
-n = Value a	IT POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown			
bit 15	CHEN: DMA	Channel Enabl	e bit							
	1 = Channel 0 = Channel									
bit 14			ze hit							
	1 = Byte	SIZE: DMA Data Transfer Size bit 1 = Byte								
	0 = Word									
bit 13	DIR: DMA Tra	ansfer Directior	n bit (source/d	estination bus	select)					
		om RAM addre om peripheral a		•						
bit 12		Block Transfer								
	1 = Initiates i	nterrupt when	half of the data	a has been mo						
bit 11		Data Periphera								
		write to periph			e (DIR bit must	also be clear)				
bit 10-6	Unimplemen	ted: Read as '	0'							
bit 5-4	AMODE<1:0	-: DMA Chann	el Addressing	Mode Select b	oits					
	11 = Reserve 10 = Periphe 01 = Register		ressing mode ut Post-Increm	nent mode						
bit 3-2	Unimplemen	ted: Read as '	0'							
bit 1-0	MODE<1:0>: DMA Channel Operating Mode Select bits									
	11 = One-Sho 10 = Continue	ot, Ping-Pong r ous, Ping-Pong ot, Ping-Pong r	nodes are ena modes are e nodes are dis	abled (one bloc nabled abled	ck transfer fror	n/to each DMA t	ouffer)			

## REGISTER 8-1: DMAXCON: DMA CHANNEL X CONTROL REGISTER

				DD20			
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
bit 15							bit 8
				RP35	iR<5:0>		
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0

## REGISTER 11-18: RPOR0: PERIPHERAL PIN SELECT OUTPUT REGISTER 0

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—			RP20	R<5:0>		
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	t, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14	Unimplemented: Read as '0'
bit 13-8	<b>RP35R&lt;5:0&gt;:</b> Peripheral Output Function is Assigned to RP35 Output Pin bits (see Table 11-3 for peripheral function numbers)
bit 7-6	Unimplemented: Read as '0'
bit 5-0	<b>RP20R&lt;5:0&gt;:</b> Peripheral Output Function is Assigned to RP20 Output Pin bits (see Table 11-3 for peripheral function numbers)

#### REGISTER 11-19: RPOR1: PERIPHERAL PIN SELECT OUTPUT REGISTER 1

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—			RP37	′R<5:0>		
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—			RP36	R<5:0>		
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14	Unimplemented: Read as '0'
bit 13-8	<b>RP37R&lt;5:0&gt;:</b> Peripheral Output Function is Assigned to RP37 Output Pin bits (see Table 11-3 for peripheral function numbers)
bit 7-6	Unimplemented: Read as '0'
bit 5-0	<b>RP36R&lt;5:0&gt;:</b> Peripheral Output Function is Assigned to RP36 Output Pin bits (see Table 11-3 for peripheral function numbers)

R/W-1	R/W-1	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PENH	PENL	POLH	POLL	PMOD1 <sup>(1)</sup>	PMOD0 <sup>(1)</sup>	OVRENH	OVRENL
bit 15		•					bit
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
-	-	-		-	-	-	R/W-0
OVRDAT1	OVRDAT0	FLTDAT1	FLTDAT0	CLDAT1	CLDAT0	SWAP	OSYNC
bit 7							bit
Legend:							
R = Readable	bit	W = Writable	bit	U = Unimpler	nented bit, read	l as '0'	
-n = Value at F	POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown
bit 15		xH Output Pin	Ownorshin hit				
bit 15		odule controls	•				
		dule controls F					
bit 14		L Output Pin	•				
	1 = PWMx mo	odule controls	PWMxL pin				
	0 = GPIO mo	dule controls F	WMxL pin				
bit 13	POLH: PWM	xH Output Pin	Polarity bit				
		oin is active-low					
		oin is active-hig	•				
bit 12		L Output Pin F	•				
		in is active-low in is active-hig					
bit 11-10	PMOD<1:0>:	PWMx # I/O F	in Mode bits <sup>(1</sup>	)			
	11 = Reserve	,					
		/O pin pair is ir /O pin pair is ir					
		O pin pair is in O pin pair is ir					
bit 9		verride Enable	•				
		<1> controls or					
		nerator contro	•	•			
bit 8	OVRENL: Ov	erride Enable	for PWMxL Pir	n bit			
	1 = OVRDAT	<0> controls or	utput on PWM	xL pin			
	•	nerator contro					
bit 7-6					de is Enabled b		
					by OVRDAT< by OVRDAT<0		
bit 5-4	FLTDAT<1:0	>: Data for PW	MxH and PWN	۰ ۸xL Pins if FLT	MOD is Enable	ed bits	
	If Fault is active	ve, PWMxH is	driven to the s	tate specified	by FLTDAT<1>.		
	If Fault is active	ve, PWMxL is	driven to the s	tate specified b	by FLTDAT<0>.		
bit 3-2	CLDAT<1:0>	: Data for PWN	/IxH and PWM	xL Pins if CLM	10D is Enabled	bits	
				•	ecified by CLDA		
		IS AULIVE. F VVI					
Note 1: The					enabled (PTEN		

## REGISTER 16-13: IOCONx: PWMx I/O CONTROL REGISTER<sup>(2)</sup>

2: If the PWMLOCK Configuration bit (FOSCSEL<6>) is a '1', the IOCONx register can only be written after the unlock sequence has been executed.

	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
		QEIG	EC<31:24>				
						bit 8	
	DAMO				DAMO		
R/W-U	R/W-0			R/W-U	R/W-U	R/W-0	
		QEIGE	EC<23:16>				
						bit (	
R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'							
-n = Value at POR '1' = Bit is set			'0' = Bit is clea	ared	x = Bit is unknown		
		W = Writable bi	R/W-0 R/W-0 QEIGI W = Writable bit	R/W-0 R/W-0 R/W-0 QEIGEC<23:16> W = Writable bit U = Unimplem	R/W-0   R/W-0   R/W-0     QEIGEC<23:16>     W = Writable bit     U = Unimplemented bit, real	R/W-0     R/W-0     R/W-0     R/W-0       QEIGEC<23:16>     U = Unimplemented bit, read as '0'	

## REGISTER 17-15: QEI1GECH: QEI1 GREATER THAN OR EQUAL COMPARE HIGH WORD REGISTER

bit 15-0 QEIGEC<31:16>: High Word Used to Form 32-Bit Greater Than or Equal Compare Register (QEI1GEC) bits

### REGISTER 17-16: QEI1GECL: QEI1 GREATER THAN OR EQUAL COMPARE LOW WORD REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			QEIGE	C<15:8>			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			QEIG	EC<7:0>			
bit 7							bit 0
Legend:							
R = Readable bit W = Writable bit			bit	U = Unimplemented bit, read as '0'			
-n = Value at POR '1' = Bit is set			'0' = Bit is cle	ared	x = Bit is unki	nown	

bit 15-0 QEIGEC<15:0>: Low Word Used to Form 32-Bit Greater Than or Equal Compare Register (QEI1GEC) bits

## FIGURE 22-1: CTMU BLOCK DIAGRAM



5: The switch connected to ADC CH0 is closed when IDISSEN (CTMUCON1<9>) = 1, and opened when IDISSEN = 0.

## 22.1 CTMU Resources

Many useful resources are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page, which can be accessed using this link, contains the latest updates and additional information.

Note:	In the event you are not able to access the
	product page using the link above, enter
	this URL in your browser:
	http://www.microchip.com/wwwproducts/
	Devices.aspx?dDocName=en555464

#### 22.1.1 KEY RESOURCES

- "Charge Time Measurement Unit (CTMU)" (DS70661) in the "dsPIC33/PIC24 Family Reference Manual"
- Code Samples
- · Application Notes
- Software Libraries
- Webinars
- All Related "dsPIC33/PIC24 Family Reference Manual" Sections
- · Development Tools

## 24.2 PTG Resources

Many useful resources are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page, which can be accessed using this link, contains the latest updates and additional information.

Note:	In the event you are not able to access the
	product page using the link above, enter
	this URL in your browser:
	http://www.microchip.com/wwwproducts/
	Devices.aspx?dDocName=en555464

#### 24.2.1 KEY RESOURCES

- "Peripheral Trigger Generator" (DS70669) in the "dsPIC33/PIC24 Family Reference Manual"
- Code Samples
- Application Notes
- · Software Libraries
- Webinars
- All Related "dsPIC33/PIC24 Family Reference Manual" Sections
- Development Tools

## REGISTER 24-4: PTGT0LIM: PTG TIMER0 LIMIT REGISTER<sup>(1)</sup>

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
	PTGT0LIM<15:8>									
bit 15 bit 8										
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
			PTGT0	LIM<7:0>						
bit 7							bit 0			
Legend:										
R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'										
-n = Value at POR (1' = Bit is set (0' = Bit is cleared x = Bit is unknown						nown				

#### bit 15-0 **PTGT0LIM<15:0>:** PTG Timer0 Limit Register bits General Purpose Timer0 Limit register (effective only with a PTGT0 Step command).

**Note 1:** This register is read-only when the PTG module is executing Step commands (PTGEN = 1 and PTGSTRT = 1).

## REGISTER 24-5: PTGT1LIM: PTG TIMER1 LIMIT REGISTER<sup>(1)</sup>

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			PTGT1LI	M<15:8>			
bit 15							bit 8

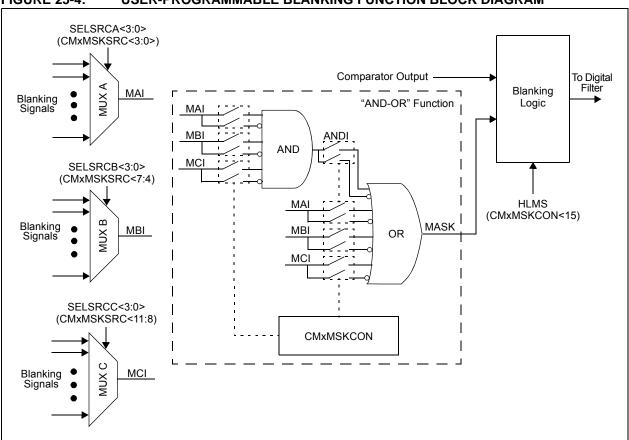
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			PTGT1L	-IM<7:0>			
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-0 **PTGT1LIM<15:0>:** PTG Timer1 Limit Register bits

General Purpose Timer1 Limit register (effective only with a PTGT1 Step command).

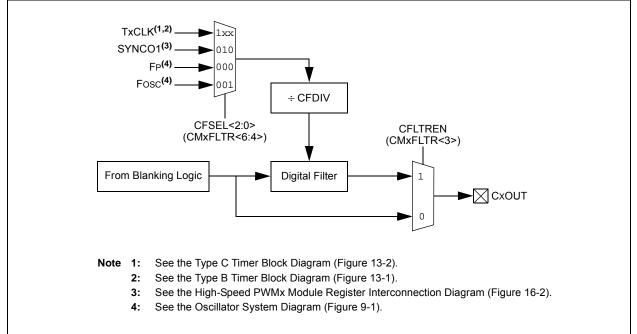
**Note 1:** This register is read-only when the PTG module is executing Step commands (PTGEN = 1 and PTGSTRT = 1).







## DIGITAL FILTER INTERCONNECT BLOCK DIAGRAM



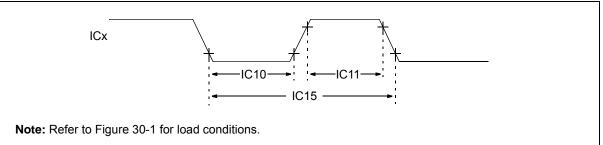
Base Instr #	Assembly Mnemonic	Assembly Syntax		Description	# of Words	# of Cycles <sup>(2)</sup>	Status Flags Affected
25	DAW			Wn = decimal adjust Wn	1	1	С
26	DEC	DEC	f	f = f - 1	1	1	C,DC,N,OV,Z
		DEC	f,WREG	WREG = f – 1	1	1	C,DC,N,OV,Z
		DEC	Ws,Wd	Wd = Ws - 1	1	1	C,DC,N,OV,Z
27	DEC2	DEC2	f	f = f - 2	1	1	C,DC,N,OV,Z
		DEC2	f,WREG	WREG = f – 2	1	1	C,DC,N,OV,Z
		DEC2	Ws,Wd	Wd = Ws - 2	1	1	C,DC,N,OV,Z
28	DISI	DISI	#lit14	Disable Interrupts for k instruction cycles	1	1	None
29	DIV	DIV.S	Wm,Wn	Signed 16/16-bit Integer Divide	1	18	N,Z,C,OV
		DIV.SD	Wm,Wn	Signed 32/16-bit Integer Divide	1	18	N,Z,C,OV
		DIV.U	Wm,Wn	Unsigned 16/16-bit Integer Divide	1	18	N,Z,C,OV
		DIV.UD	Wm,Wn	Unsigned 32/16-bit Integer Divide	1	18	N,Z,C,OV
30	DIVF	DIVF	Wm , Wn <sup>(1)</sup>	Signed 16/16-bit Fractional Divide	1	18	N,Z,C,OV
31	DO	DO	#lit15,Expr <sup>(1)</sup>	Do code to PC + Expr, lit15 + 1 times	2	2	None
		DO	Wn, Expr(1)	Do code to PC + Expr, (Wn) + 1 times	2	2	None
32	ED	ED	Wm*Wm,Acc,Wx,Wy,Wxd <sup>(1)</sup>	Euclidean Distance (no accumulate)	1	1	OA,OB,OAB, SA,SB,SAB
33	EDAC	EDAC	Wm*Wm,Acc,Wx,Wy,Wxd <sup>(1)</sup>	Euclidean Distance	1	1	OA,OB,OAB, SA,SB,SAB
34	EXCH	EXCH	Wns,Wnd	Swap Wns with Wnd	1	1	None
35	FBCL	FBCL	Ws,Wnd	Find Bit Change from Left (MSb) Side	1	1	С
36	FF1L	FF1L	Ws,Wnd	Find First One from Left (MSb) Side	1	1	С
37	FF1R	FF1R	Ws,Wnd	Find First One from Right (LSb) Side	1	1	С
38	GOTO	GOTO	Expr	Go to address	2	4	None
		GOTO	Wn	Go to indirect	1	4	None
		GOTO.L	Wn	Go to indirect (long address)	1	4	None
39	INC	INC	f	f = f + 1	1	1	C,DC,N,OV,Z
		INC	f,WREG	WREG = f + 1	1	1	C,DC,N,OV,Z
		INC	Ws,Wd	Wd = Ws + 1	1	1	C,DC,N,OV,Z
40	INC2	INC2	f	f = f + 2	1	1	C,DC,N,OV,Z
		INC2	f,WREG	WREG = f + 2	1	1	C,DC,N,OV,Z
		INC2	Ws,Wd	Wd = Ws + 2	1	1	C,DC,N,OV,Z
41	IOR	IOR	f	f = f .IOR. WREG	1	1	N,Z
		IOR	f,WREG	WREG = f .IOR. WREG	1	1	N,Z
		IOR	#lit10,Wn	Wd = lit10 .IOR. Wd	1	1	N,Z
		IOR	Wb,Ws,Wd	Wd = Wb .IOR. Ws	1	1	N,Z
		IOR	Wb,#lit5,Wd	Wd = Wb .IOR. lit5	1	1	N,Z
42	LAC	LAC	Wso,#Slit4,Acc	Load Accumulator	1	1	OA,OB,OAB, SA,SB,SAB
43	LNK	LNK	#lit14	Link Frame Pointer	1	1	SFA
44	LSR	LSR	f	f = Logical Right Shift f	1	1	C,N,OV,Z
		LSR	f,WREG	WREG = Logical Right Shift f	1	1	C,N,OV,Z
		LSR	Ws,Wd	Wd = Logical Right Shift Ws	1	1	C,N,OV,Z
		LSR	Wb,Wns,Wnd	Wnd = Logical Right Shift Wb by Wns	1	1	N,Z
		LSR	Wb,#lit5,Wnd	Wnd = Logical Right Shift Wb by lit5	1	1	N,Z
45	MAC	MAC	Wm*Wn,Acc,Wx,Wxd,Wy,Wyd,AWB <sup>(1)</sup>	Multiply and Accumulate	1	1	OA,OB,OAB, SA,SB,SAB
		MAC Wm*Wm, Acc, Wx, Wxd, Wy, Wyd <sup>(1)</sup> Square and Accumulate		Square and Accumulate	1	1	OA,OB,OAB, SA,SB,SAB

## TABLE 28-2: INSTRUCTION SET OVERVIEW (CONTINUED)

Note 1: These instructions are available in dsPIC33EPXXXMC20X/50X and PIC24EPXXXMC20X devices only.

2: Read and Read-Modify-Write (e.g., bit operations and logical operations) on non-CPU SFRs incur an additional instruction cycle.

## FIGURE 30-6: INPUT CAPTURE x (ICx) TIMING CHARACTERISTICS



### TABLE 30-26: INPUT CAPTURE x MODULE TIMING REQUIREMENTS

AC CHA	RACTERI	STICS	$\begin{array}{ll} \mbox{Standard Operating Conditions: 3.0V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ -40^{\circ}C \leq TA \leq +125^{\circ}C \mbox{ for Extended} \end{array}$					
Param. No.	Symbol	Characteristics <sup>(1)</sup>	Min. Max. Units Conditions				ditions	
IC10	TccL	ICx Input Low Time	Greater of 12.5 + 25 or (0.5 Tcy/N) + 25		ns	Must also meet Parameter IC15		
IC11	ТссН	ICx Input High Time	Greater of 12.5 + 25 or (0.5 Tcy/N) + 25	—	ns	Must also meet Parameter IC15	N = prescale value (1, 4, 16)	
IC15	TccP	ICx Input Period	Greater of 25 + 50 or (1 Tcy/N) + 50	_	ns	(1, 4, 10)		

**Note 1:** These parameters are characterized, but not tested in manufacturing.

# TABLE 30-47:SPI1 SLAVE MODE (FULL-DUPLEX, CKE = 0, CKP = 1, SMP = 0)TIMING REQUIREMENTS

АС СНА	AC CHARACTERISTICS			perating erwise sta mperatur	<b>ated)</b> e -40°	C ≤ TA ≤	<b>V to 3.6V</b> +85°C for Industrial +125°C for Extended
Param.	Symbol	Characteristic <sup>(1)</sup>	Min.	Typ. <sup>(2)</sup>	Max.	Units	Conditions
SP70	FscP	Maximum SCK1 Input Frequency	—	—	15	MHz	(Note 3)
SP72	TscF	SCK1 Input Fall Time	—	—	_	ns	See Parameter DO32 (Note 4)
SP73	TscR	SCK1 Input Rise Time	—	—	_	ns	See Parameter DO31 (Note 4)
SP30	TdoF	SDO1 Data Output Fall Time	—	_	_	ns	See Parameter DO32 (Note 4)
SP31	TdoR	SDO1 Data Output Rise Time	—	—	_	ns	See Parameter DO31 (Note 4)
SP35	TscH2doV, TscL2doV	SDO1 Data Output Valid after SCK1 Edge	—	6	20	ns	
SP36	TdoV2scH, TdoV2scL	SDO1 Data Output Setup to First SCK1 Edge	30	—	_	ns	
SP40	TdiV2scH, TdiV2scL	Setup Time of SDI1 Data Input to SCK1 Edge	30	—	_	ns	
SP41	TscH2diL, TscL2diL	Hold Time of SDI1 Data Input to SCK1 Edge	30	—	_	ns	
SP50	TssL2scH, TssL2scL	SS1 ↓ to SCK1 ↑ or SCK1 ↓ Input	120	—	_	ns	
SP51	TssH2doZ	SS1 ↑ to SDO1 Output High-Impedance	10	—	50	ns	(Note 4)
SP52	TscH2ssH, TscL2ssH	SS1	1.5 Tcy + 40	—		ns	(Note 4)

**Note 1:** These parameters are characterized, but are not tested in manufacturing.

2: Data in "Typical" column is at 3.3V, +25°C unless otherwise stated.

**3:** The minimum clock period for SCK1 is 66.7 ns. Therefore, the SCK1 clock generated by the master must not violate this specification.

4: Assumes 50 pF load on all SPI1 pins.



#### FIGURE 30-29: SPI1 SLAVE MODE (FULL-DUPLEX, CKE = 0, CKP = 0, SMP = 0) TIMING CHARACTERISTICS

## 31.0 HIGH-TEMPERATURE ELECTRICAL CHARACTERISTICS

This section provides an overview of dsPIC33EPXXXGP50X, dsPIC33EPXXXMC20X/50X and PIC24EPXXXGP/ MC20X electrical characteristics for devices operating in an ambient temperature range of -40°C to +150°C.

The specifications between  $-40^{\circ}$ C to  $+150^{\circ}$ C are identical to those shown in **Section 30.0** "**Electrical Characteristics**" for operation between  $-40^{\circ}$ C to  $+125^{\circ}$ C, with the exception of the parameters listed in this section.

Parameters in this section begin with an H, which denotes High temperature. For example, Parameter DC10 in **Section 30.0 "Electrical Characteristics"** is the Industrial and Extended temperature equivalent of HDC10.

Absolute maximum ratings for the dsPIC33EPXXXGP50X, dsPIC33EPXXXMC20X/50X and PIC24EPXXXGP/MC20X high-temperature devices are listed below. Exposure to these maximum rating conditions for extended periods can affect device reliability. Functional operation of the device at these or any other conditions above the parameters indicated in the operation listings of this specification is not implied.

## Absolute Maximum Ratings<sup>(1)</sup>

Ambient temperature under bias <sup>(2)</sup>	40°C to +150°C
Storage temperature	65°C to +160°C
Voltage on VDD with respect to Vss	-0.3V to +4.0V
Voltage on any pin that is not 5V tolerant with respect to Vss <sup>(3)</sup>	0.3V to (VDD + 0.3V)
Voltage on any 5V tolerant pin with respect to Vss when VDD < 3.0V <sup>(3)</sup>	0.3V to 3.6V
Voltage on any 5V tolerant pin with respect to Vss when $VDD \ge 3.0V^{(3)}$	0.3V to 5.5V
Maximum current out of Vss pin	60 mA
Maximum current into Vod pin <sup>(4)</sup>	60 mA
Maximum junction temperature	+155°C
Maximum current sourced/sunk by any 4x I/O pin	10 mA
Maximum current sourced/sunk by any 8x I/O pin	15 mA
Maximum current sunk by all ports combined	70 mA
Maximum current sourced by all ports combined <sup>(4)</sup>	70 mA

- **Note 1:** Stresses above those listed under "Absolute Maximum Ratings" can cause permanent damage to the device. This is a stress rating only, and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods can affect device reliability.
  - 2: AEC-Q100 reliability testing for devices intended to operate at +150°C is 1,000 hours. Any design in which the total operating time from +125°C to +150°C will be greater than 1,000 hours is not warranted without prior written approval from Microchip Technology Inc.
  - 3: Refer to the "Pin Diagrams" section for 5V tolerant pins.
  - 4: Maximum allowable current is a function of device maximum power dissipation (see Table 31-2).

## TABLE 31-11: INTERNAL RC ACCURACY

AC CH	ARACTERISTICS	$\begin{tabular}{ l l l l l l l l l l l l l l l l l l l$						
Param No.	Characteristic	Min	Тур	Max	Units	Conditions		
	LPRC @ 32.768 kHz <sup>(1,2)</sup>							
HF21	LPRC	-30	_	+30	%	$-40^{\circ}C \leq TA \leq +150^{\circ}C$	VDD = 3.0-3.6V	

Note 1: Change of LPRC frequency as VDD changes.

2: LPRC accuracy impacts the Watchdog Timer Time-out Period (TwDT). See Section 27.5 "Watchdog Timer (WDT)" for more information.

## **PRODUCT IDENTIFICATION SYSTEM**

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

Microchip Tradema Architecture — Flash Memory Fam Program Memory S Product Group — Pin Count — Tape and Reel Flag Temperature Range Package Pattern	Examples: dsPIC33EP64MC504-I/PT: dsPIC33, Enhanced Performance, 64-Kbyte Program Memory, Motor Control, 44-Pin, Industrial Temperature, TQFP package.			
Architecture:	33 24	= =	16-bit Digital Signal Controller 16-bit Microcontroller	
Flash Memory Family:	EP	=	Enhanced Performance	
Product Group:	GP MC	= =	General Purpose family Motor Control family	
Pin Count:	02 03 04 06	=	36-pin 44-pin	
Temperature Range:	l E	= =	-40°C to+85°C (Industrial) -40°C to+125°C (Extended)	
Package:	ML MR MV PT SO SP SS TL TL		Skinny Plastic Dual In-Line - (28-pin) 300 mil body (SPDIP) Plastic Shrink Small Outline - (28-pin) 5.30 mm body (SSOP) Very Thin Leadless Array - (36-pin) 5x5 mm body (VTLA)	

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